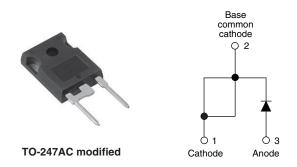
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Hyperfast Rectifier, 30 A FRED Pt®



PRIMARY CHARACTERISTICS							
I _{F(AV)} 30 A							
V _R	600 V						
V _F at I _F	1.34 V						
t _{rr} typ.	See Recovery table						
T _J max.	175 °C						
Package	TO-247AC modified						
Circuit configuration	Single						

FEATURES

- Hyperfast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Low leakage current
- Single diode device
- Designed and qualified according to JEDEC[®]-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS, inverters or as freewheeling diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Peak repetitive reverse voltage	V _{RRM}		600	V				
Average rectified forward current	I _{F(AV)}	T _C = 116 °C	30	٨				
Non-repetitive peak surge current	I _{FSM}	T _J = 25 °C	300	A				
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C				

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	TEST CONDITIONS MIN. TYP. MAX.						
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	600	-	-				
Forward valtage	V	I _F = 30 A	-	2.0	2.6	V			
Forward voltage V _F	۷F	I _F = 30 A, T _J = 150 °C	-	1.34	1.75				
Deveree leekees eurrent		V _R = V _R rated	-	0.3	50				
Reverse leakage current I _R		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	60	500	μA			
Junction capacitance	CT	V _R = 600 V	-	33	-	pF			
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	3.5	-	nH			





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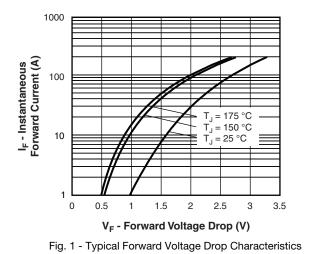
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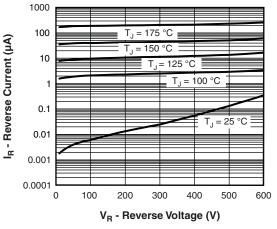
DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t =$	= 50 A/µs, V _R = 30 V	-	28	35			
Reverse recovery time	t _{rr}	$T_J = 25 \ ^\circ C$	I _F = 30 A dI _F /dt = 200 A/μs V _R = 200 V	-	31	-	ns		
		T _J = 125 °C		-	77	-			
Deale receiver a current		$T_J = 25 \ ^\circ C$		-	3.5	-	А		
Peak recovery current	I _{RRM}	T _J = 125 °C		-	7.7	-	A		
D	0	$T_J = 25 \ ^\circ C$		-	65	-	nC		
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	345	-	10		

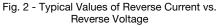
THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C		
Thermal resistance, junction to case per leg	R _{thJC}		-	0.5	0.9			
Thermal resistance, junction to ambient per leg	R _{thJA}	Typical socket mount	-	-	70	°C/W		
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.4	-			
Weight			-	6.0	-	g		
Weight			-	0.22	-	oz.		
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)		
Marking device		Case style TO-247AC modified		30EF	PH06			

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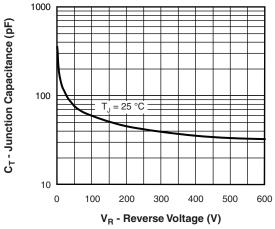


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

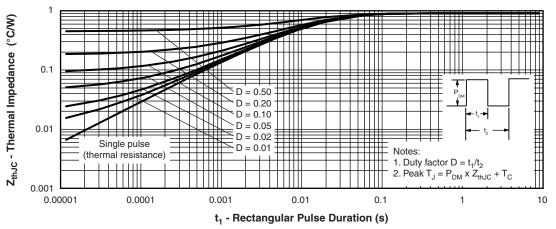


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

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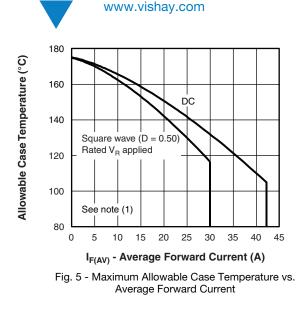
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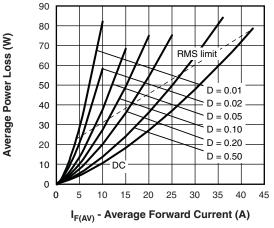


Fig. 6 - Forward Power Loss Characteristics

Note

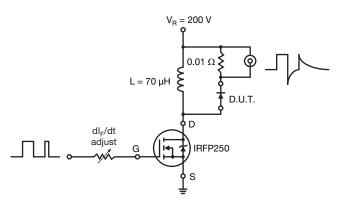


Fig. 9 - Reverse Recovery Parameter Test Circuit

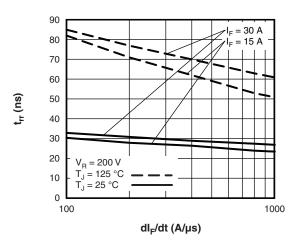


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

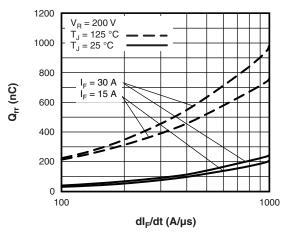
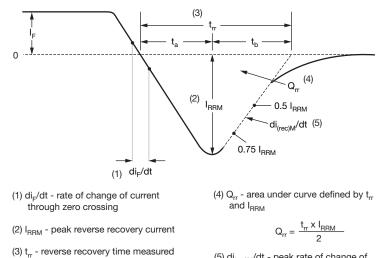


Fig. 8 - Typical Stored Charge vs. dl_F/dt

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from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current. (5) di_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

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Device code	VS-	30	Е	Р	н	06	PbF
		2	3	4	5	6	7
	1		,	nicondu		oduct	
	2	- Cur	rent rati	ing (30 =	= 30 A)		
	3	- Ciro	cuit conf	figuratio	n:		
		E =	single of	diode			
	4	- Pao	kage:				
		P =	TO-247	7AC mo	dified		
	5	. н=	hyperfa	ast recov	very		
	6	- Vol	tage rati	ing (06 =	= 600 V)	
	7 -	Env	rironmer	ntal digit	:		
		PbF	= lead	(Pb)-fre	e and R	loHS-co	ompliant
		-N3	= halog	gen-free	, RoHS-	complia	ant and

 ORDERING INFORMATION (Example)

 PREFERRED P/N
 QUANTITY PER T/R
 MINIMUM ORDER QUANTITY
 PACKAGING DESCRIPTION

 VS-30EPH06PbF
 25
 500
 Antistatic plastic tube

 VS-30EPH06-N3
 25
 500
 Antistatic plastic tube

LINKS TO RELATED DOCUMENTS							
Dimensions		www.vishay.com/doc?95541					
Part marking information	TO-247AC modified PbF	www.vishay.com/doc?95255					
	TO-247AC modified -N3	www.vishay.com/doc?95442					
SPICE model		www.vishay.com/doc?96573					
Bevision: 05-Nov-2018		Document Number: 9/018					

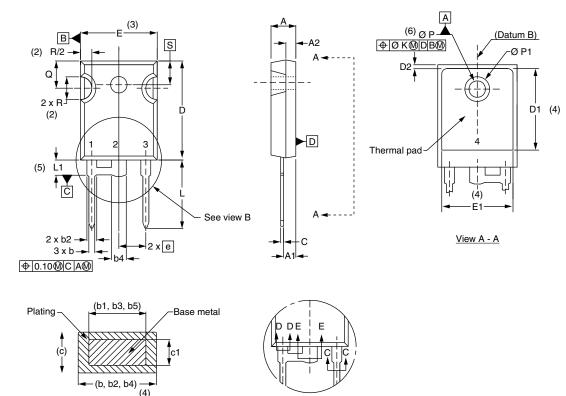
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TO-247AC modified - 50 mils L/F

DIMENSIONS in millimeters and inches



Section C - C, D - D, E - E

View	B

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
с	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INC	HES	NOTES	
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
D2	0.51	1.35	0.020	0.053		
E	15.29	15.87	0.602	0.625	3	
E1	13.46	-	0.53	-		
е	5.46	BSC	0.215	0.215 BSC		
ØК	0.254		0.010			
L	14.20	16.10	0.559	0.634		
L1	3.71	4.29	0.146	0.169		
ØР	3.56	3.66	0.14	0.144		
Ø P1	-	7.39	-	0.291		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	0.178	0.216		
S	5.51	BSC	0.217 BSC			

Notes

- ⁽¹⁾ Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- ⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-247 with exception of dimension c and Q

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